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		Application Number	10/810,008		
		Filing Date	March 26, 2004		
		First Named Inventor	Durant		
		Art Unit			
Examiner Name					
Sheet	2	of	2	Attorney Docket Number	040075

<b>NON PATENT LITERATURE DOCUMENTS</b>			
Examiner Initials*	Cite No. <sup>1</sup>	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published	T <sup>2</sup>
OS		Cruse, E., "An Integrated Thermal Architecture For Thermal Management Of High Power Electronics," Cooling Zone's Monthly Online Magazine, Vol. 3, No. 1, January, 2003, available on April 15, 2004 at <a href="http://www.coolingzone.com/Guest/News/NL_JAN_2003/Thermacore/Thermacore_Jan_2003.html">http://www.coolingzone.com/Guest/News/NL_JAN_2003/Thermacore/Thermacore_Jan_2003.html</a> .	
		"Enabling Intelligent Platform Management Interface (IPMI) Through Standard Building Blocks," Intel Corporation White Paper, June, 2002, available on April 15, 2004 at <a href="http://www.intel.com/platforms/applied/eiacomm/papers/25133701.pdf">http://www.intel.com/platforms/applied/eiacomm/papers/25133701.pdf</a> .	
		"FFB 30 x 80 x38 MM Series," Delta Electronics, Inc. Online Catalog, pg. 32, 2002-2003, available on April 15, 2004 at <a href="http://www.delta.com.tw/products/dcfans/pdf/FFB808038.pdf">http://www.delta.com.tw/products/dcfans/pdf/FFB808038.pdf</a> .	
		Hanrahan, D., "Fan-Speed Control Techniques In PCs," Analog Dialogue, Vol. 34, No. 4, June-July, 2000, available on April 15, 2004 at <a href="http://www.analog.com/library/analogDialogue/archives/34-04/fan/">http://www.analog.com/library/analogDialogue/archives/34-04/fan/</a>	
		"IPMI v1.5 Overview," Intel Corporation White Paper, 2001, available on April 15, 2004 at <a href="http://developer.intel.com/design/servers/IPMI15Whitepaper.pdf">http://developer.intel.com/design/servers/IPMI15Whitepaper.pdf</a> .	
		Kundert, J., "For Optimal Cooling, Rely On Closed-Loop, Fan-Speed Control," Electronic Design, July 6, 1998, available on April 15, 2004 at <a href="http://www.findarticles.com/cf_dls/m3161n16_v46/20929121/print.html">http://www.findarticles.com/cf_dls/m3161n16_v46/20929121/print.html</a> .	
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		Paparrizos, G., "An Integrated Fan Speed Control Solution Can Lower System Costs, Reduce Acoustic Noise, Power Consumption and Enhance System Reliability," February 12, 2003, Microchip Technology, Inc. Application Note, available on April 15, 2004 at <a href="http://www.microchip.com/download/appnote/thermal/tb063a.pdf">www.microchip.com/download/appnote/thermal/tb063a.pdf</a> .	
		"PIC16F87X Datasheet," Microchip Technology Inc. Product Datasheet, pgs. 57-110, January 30, 2001, available on April 15, 2004 at <a href="http://www.microchip.com/download/lit/pline/picmicro/families/16f87x/30292c.pdf">http://www.microchip.com/download/lit/pline/picmicro/families/16f87x/30292c.pdf</a> .	
		Stancil, C., "Keeping PCs Cool And Quiet," Compaq Computer Corporation, available on April 15, 2004 at <a href="http://www.robbrownstein.com/assets/Keeping%20PCs%20Cool%20And%20Quiet.pdf">http://www.robbrownstein.com/assets/Keeping%20PCs%20Cool%20And%20Quiet.pdf</a> .	

Examiner Signature	CT	Date Considered	5/12/06
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